



General Description

The MAX8848Y/MAX8848Z negative charge pumps drive up to 7 white LEDs with regulated constant current for display backlight applications. By utilizing an inverting charge pump and extremely low-dropout adaptive current regulators, these ICs achieve very high efficiency over the full 1-cell Li+ battery voltage range even with large LED forward voltage mismatch. The 1MHz fixedfrequency switching allows for tiny external components. The regulation scheme is optimized to ensure low EMI and low input ripple. The MAX8848Y/MAX8848Z include thermal shutdown, open- and short-circuit protection.

The MAX8848Y/MAX8848Z support independent LED on/off and dimming control. The MAX8848Y dimming ranges are pseudo-logarithmic from 24mA to 0.1mA and off in 32 steps. All devices include a temperature derating function to safely allow bright 24mA full-scale output current while automatically reducing current gradually to protect LEDs at high ambient temperatures above +60°C.

The MAX8848Y/MAX8848Z are available in 16-pin, 3mm x 3mm thin QFN packages.

Applications

White LED Backlighting Cellular Phones PDAs, Digital Cameras, and Camcorders

Ordering Information

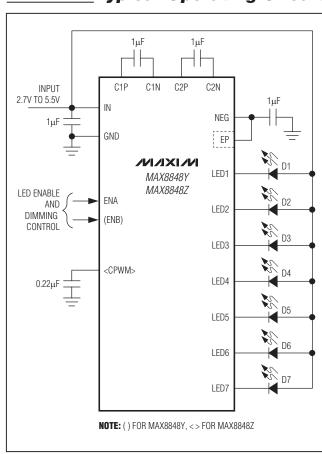
PART	ART DIMMING PIN-PACKAGE		TOP MARK
MAX8848YETE+T	Serial pulse/ PWM	16 Thin QFN-EP*	AHQ
MAX8848ZETE+T	PWM	16 Thin QFN-EP*	AHP

Note: All devices are specified over the -40°C to +85°C extended temperature range.

Features

- ♦ Negative 1x/1.5x Charge Pump
- Adaptive Current Regulators
- Independent Voltage Supply for Each LED
- ◆ 24mA to 0.1mA Serial-Pulse Dimming (MAX8848Y)
- ◆ 24mA to 0mA PWM Dimming (MAX8848Z)
- ◆ 2% (max) LED Current Accuracy, 1% (typ) Matching
- ♦ Low 120µA Quiescent Current
- Low 0.4uA Shutdown Current
- **♦ Inrush Current Limit**
- **♦ Temperature Derating Function**
- ♦ 16-Pin, 3mm x 3mm Thin QFN Packages

Typical Operating Circuit



⁺Denotes a lead(Pb)-free/RoHS-compliant package.

^{*}EP = Exposed pad.

ABSOLUTE MAXIMUM RATINGS

IN to GND0.3V to +6.0V IN to NEG0.3V to +6.0V
NEG, C2N to GND6V to +0.3V
C1P, C2P, CPWM, ENA, ENB to GND0.3V to (VIN + 0.3V)
C2P to C1N0.3V to (V _{IN} + 0.3V)
LED_, C1N, C2N, ENA, ENB to NEG0.3V to ($V_{\mbox{\footnotesize{IN}}}$ + 0.3V)
Continuous Power Dissipation (TA = +70°C)
16-Pin Thin QFN Multilayer PCB
(derate 20.8mW/°C above +70°C)1666.7mW

Junction-to-Case Thermal Resistance (θυς Junction-to-Ambient Thermal Resistance (
Multilayer PCB	, ,
Operating Temperature Range	40°C to +85°C
Junction Temperature	+150°C
Storage Temperature Range	65°C to +150°C
Lead Temperature (soldering, 10s)	+300°C
Soldering Temperature (reflow)	+260°C

Note 1: Package thermal resistances were obtained using the method described in JEDEC specification JESD51-7, using a four-layer board. For detailed information on package thermal considerations, refer to www.maxim-ic.com/thermal-tutorial.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

 $(V_{IN} = 3.6V, V_{GND} = 0V, T_A = -40^{\circ}C \text{ to } +85^{\circ}C, \text{ unless otherwise noted.}$ Typical values are at $T_A = +25^{\circ}C.$) (Note 2)

PARAMETER	CON	DITIONS	MIN	TYP	MAX	UNITS
IN Operating Voltage			2.7		5.5	V
Undervoltage Lockout (UVLO) Threshold	V _{IN} rising	V _{IN} rising		2.45	2.55	V
Undervoltage Lockout Hysteresis				100		mV
INI Chutdaus Cuaalu Currant	\/=\ O\/ all autauta aff	TA = +25°C		0.4	2.5	
IN Shutdown Supply Current	VEN_ = 0V, all outputs off	T _A = +85°C		0.4		μA
	Charge pump inactive, 2 L	EDs enabled at 0.1mA setting		120	150	μΑ
IN Operating Supply Current	Charge pump active, 1MH at 0.1mA setting	Charge pump active, 1MHz switching, all LEDs enabled at 0.1mA setting		1.6		mA
Thermal Shutdown Threshold				+160		°C
Thermal Shutdown Hysteresis				20		°C
PWM DIMMING CONTROL (M	AX8848Z)					
PWM Low-Level Input					0.4	V
PWM High-Level Input			1.4			V
EN_ PWM Input Signal Frequency Range	С _{СРWМ} = 0.22µF		0.2		200	kHz
PWM Dimming Filter Corner Frequency	С _{СРWМ} = 0.22µF			2		Hz
Current Dimming Range	Duty cycle = 0 to 100%		0		24	mA
PWM Dimming Resolution	1% ≤ duty cycle ≤ 100%			0.24		mA/%
SERIAL-PULSE LOGIC (MAX	3848Y)					
EN_ Logic Input High Voltage			1.4			V
EN_ Logic Input Low Voltage					0.4	V
EN Logio Input Current	V _{IL} = 0V or V _{IH} = 5.5V	T _A = +25°C	-1	0.01	+1	
EN_ Logic-Input Current	VIL = 0 V OI VIH = 5.5 V	T _A = +85°C	0.1			μΑ

ELECTRICAL CHARACTERISTICS (continued)

 $(V_{IN} = 3.6V, V_{GND} = 0V, T_{A} = -40$ °C to +85°C, unless otherwise noted. Typical values are at $T_{A} = +25$ °C.) (Note 2)

PARAMETER	CON	NDITIONS	MIN	TYP	MAX	UNITS	
EN_ Low Shutdown Delay tSHDN			5	8		ms	
EN_ tLO	See Figure 2	See Figure 2			500	μs	
EN_ tHI	See Figure 2		1			μs	
Initial EN_ t _{INIT}	See Figure 2, first EN_ hig	gh pulse	120			μs	
CHARGE PUMP							
Switching Frequency				1		MHz	
Soft-Start Time				0.5		ms	
Output Regulation Voltage	VIN - VNEG		4.3	5		V	
Open-Loop NEG Output Resistance	(V _{NEG} - 0.5 × V _{IN})/I _{NEG}			2	4	Ω	
NEG Shutdown Discharge Resistance	V _{EN} _ = 0V, all outputs off			10		kΩ	
LED1-LED7 CURRENT REG	ULATOR						
Current Setting Range	Serial-pulse interface or P	PWM	0.1		24.0	mA	
		24mA setting, T _A = +25°C	-2	±1	+2		
LED_ Current Accuracy	VLED_= 0.5V for charge pump inactive, VLED_ = -0.9V, VNEG = -1.4V	24mA setting, T _A = -40°C to derating function start temperature (Note 3)	-5		+5	%	
	VINEG_= 1.1V	1.6mA setting, T _A = +25°C		±5		1	
Derating Function Start Temperature				+60		°C	
Derating Function Slope	From derating function sta	art temperature		-2.5		%/°C	
	Charge pump inactive,	TA = +25°C		85	125		
LED_ Dropout Voltage	24mA setting	TA = +85°C		95		mV	
(Note 4)	Charge pump active,	T _A = +25°C		110			
	24mA setting	T _A = +85°C		124			
LED_ Current Regulator Switchover Threshold (Inactive to Active)	V _{LED} _ falling		135	150	165	mV	
LED_ Current Regulator Switchover Hysteresis				100		mV	
LED_ Leakage in Shutdown	All LEDs off	TA = +25°C TA = +85°C		0.01	5	μA	

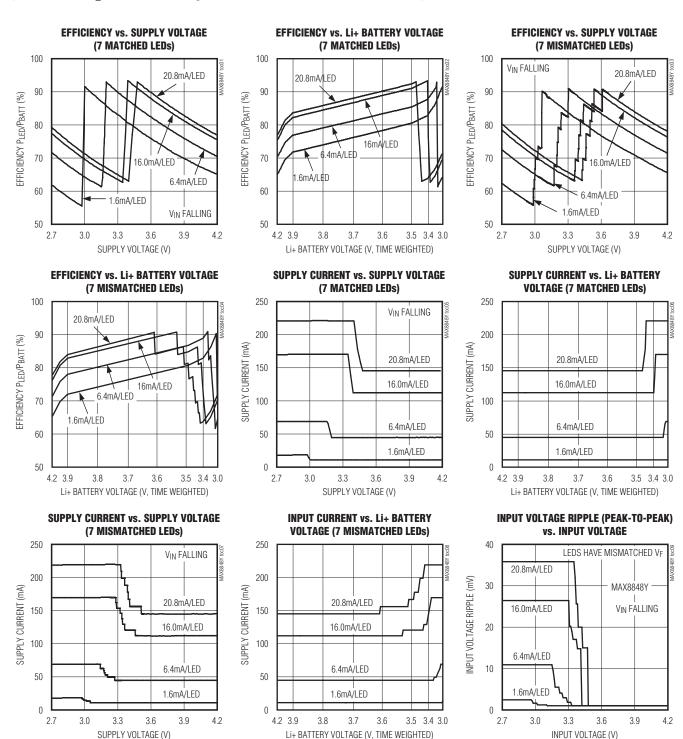
Note 2: Limits are 100% production tested at $T_A = +25$ °C. Limits over the operating temperature range are guaranteed by design.

Note 3: Guaranteed by design. Not production tested.

Note 4: LED dropout voltage is defined as the LED_ to GND voltage at which current into LED_ drops 10% from the value at VLED_ = 0.5V.

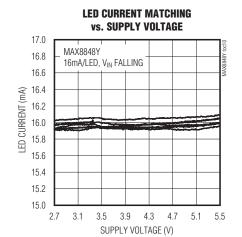
Typical Operating Characteristics

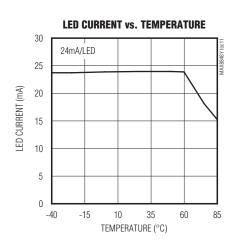
(V_{IN} = 3.6V, V_{EN} = V_{IN}, circuit of Figure 1, T_A = +25°C, unless otherwise noted.)

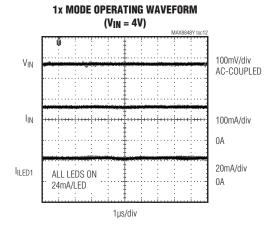


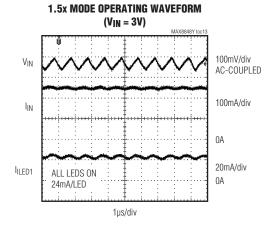
Typical Operating Characteristics (continued)

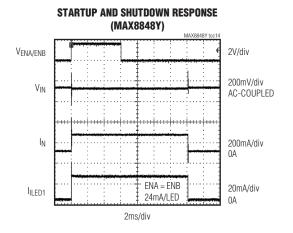
 $(V_{IN} = 3.6V, V_{EN} = V_{IN}, \text{ circuit of Figure 1, T}_{A} = +25^{\circ}\text{C}, \text{ unless otherwise noted.})$

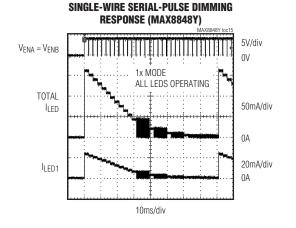






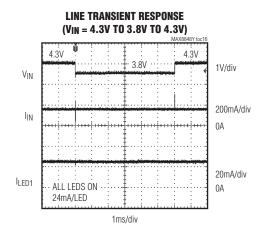


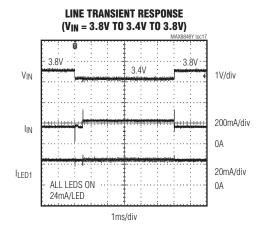


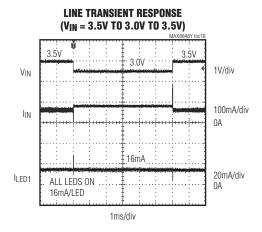


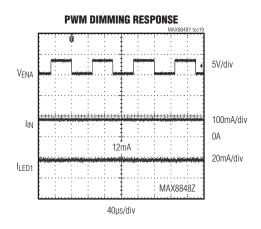
Typical Operating Characteristics (continued)

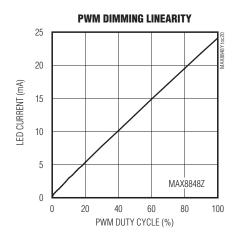
 $(V_{IN} = 3.6V, V_{EN} = V_{IN}, \text{ circuit of Figure 1, } T_{A} = +25^{\circ}\text{C}, \text{ unless otherwise noted.})$



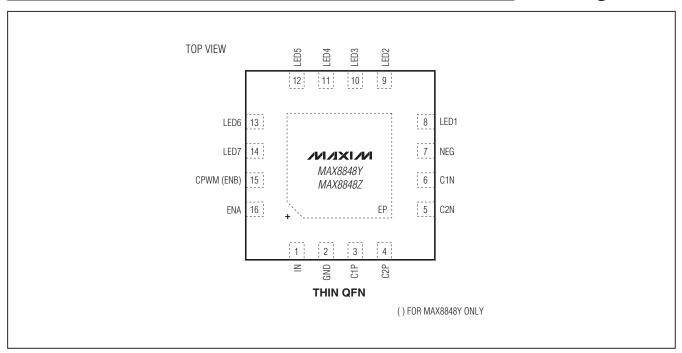








Pin Configuration



Pin Description

PIN		NAME	FUNCTION		
MAX8848Y	MAX8848Z	NAME	FUNCTION		
1	1	IN	Supply Voltage Input. The input voltage range is 2.7V to 5.5V. Bypass IN to GND with a 1µF ceramic capacitor as close as possible to the IC. IN is high impedance during shutdown. Connect IN to the anodes of all the LEDs.		
2	2	GND	Ground. Connect GND to system ground and the input bypass capacitor as close as possible to the IC.		
3	3	C1P	Transfer Capacitor 1 Positive Connection. Connect a 1µF ceramic capacitor from C1P to C1N.		
4	4	C2P	Transfer Capacitor 2 Positive Connection. Connect a 1µF ceramic capacitor from C2P to C2N.		
5	5	C2N	Transfer Capacitor 2 Negative Connection. Connect a 1μF ceramic capacitor from C2P to C2N. An internal 10kΩ resistor pulls C2N to GND during shutdown.		
6	6	C1N	Transfer Capacitor 1 Negative Connection. Connect a 1µF ceramic capacitor from C1P to C1N.		
7	7	NEG	Charge-Pump Negative Output. Connect a 1 μ F ceramic capacitor from NEG to GND. In shutdown, an internal 10 $k\Omega$ resistor pulls NEG to GND. Connect the exposed pad to NEG directly under the IC.		

_Pin Description (continued)

PIN		NAME	FUNCTION		
MAX8848Y	MAX8848Y MAX8848Z				
8–14	8–14	LED1-LED7	LED Current Regulators. Current flowing into LED_ is based on the ENA/ENB input. Connect LED_ to the cathodes of the external LEDs. LED_ is high impedance during shutdown. Short any unused LED_ to IN prior to power-up to disable the corresponding current regulator.		
15	_	ENB	Enable and Serial-Pulse Dimming Control Input B for the MAX8848Y. ENB controls LED6 and LED7. Drive ENB high to turn on the LED6 and LED7 current regulators at 24mA. Drive ENB low for greater than 8ms to turn off the current regulators or drive both ENA and ENB low to place the IC in shutdown. In addition to the enable function, ENB can also be used to control the LED6 and LED7 serial-pulse dimming.		
_	15	CPWM	Filter Capacitor Connection for PWM Dimming for the MAX8848Z. Connect a capacitor from CPWM to GND to form a filter with the internal $360k\Omega$ resistor. The recommended capacitor for a 2Hz corner frequency is $0.22\mu F$.		
16	16	ENA	Enable and PWM/Serial-Pulse Dimming Control Input A. ENA controls LED1–LED5 for the MAX8848Y, and LED1–LED7 for MAX8848Z. Drive ENA high to turn on all the controlled LED current regulators at 24mA. Drive ENA low for greater than 8ms to turn off the current regulators or drive both ENA and ENB low to place the IC in shutdown. Drive ENA with a PWM signal from 200Hz to 200kHz to dim LED1–LED7 for the MAX8848Z. See the <i>PWM Dimming Control (MAX8848Z)</i> section. For the MAX8848Y, ENA controls the LED1–LED5 serial-pulse dimming.		
_	_	EP	Exposed Paddle. Connect EP to NEG directly under the IC.		

8 ______ **NIXI/N**

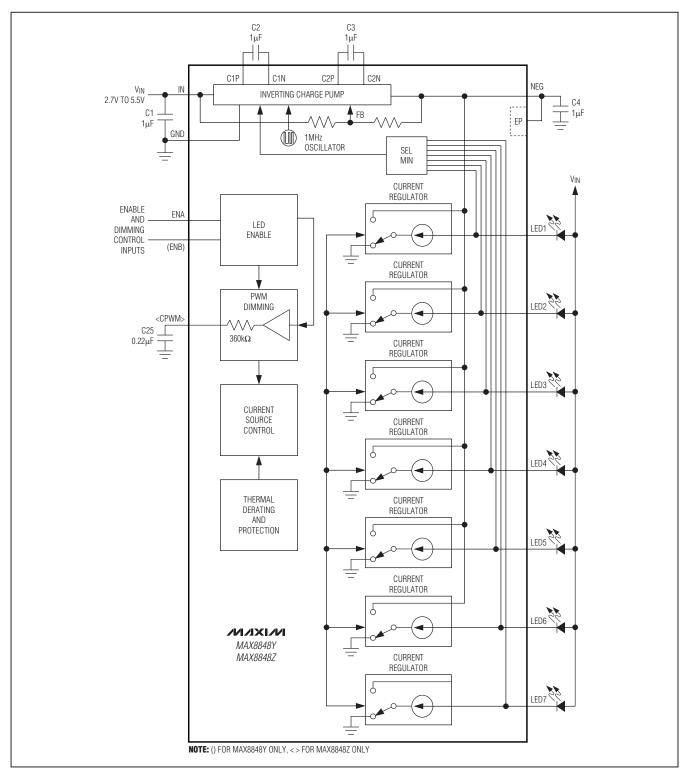


Figure 1. Functional Diagram and Application Circuit

Detailed Description

The MAX8848Y/MAX8848Z have an inverting charge pump and seven current regulators capable of 24mA each to drive up to 7 white LEDs. The current regulators are matched to within 1% (typ) providing uniform white LED brightness for LCD backlight applications. To maximize efficiency, the current regulators operate with as little as 0.15V voltage drop.

Individual white LED current regulators conduct current to GND or NEG to extend usable battery life. In the case of mismatched forward voltage of white LEDs, only the white LEDs requiring higher voltage are switched to pull current to NEG instead of GND, further raising efficiency and reducing battery current drain.

Current Regulator Switchover

When VIN is higher than the LED forward voltage plus the 150mV dropout voltage of the current regulator, the LED current returns through GND. If this condition is satisfied for all active white LEDs, the charge pump remains inactive. When the input voltage drops so that the current regulator voltage (VLED) cannot be maintained for any of the individual white LEDs, the inverting charge pump activates and generates a voltage on NEG that is no greater than 5V below VIN. For any current regulator that is detected at the switchover threshold voltage of 150mV (typ, V_{IN} falling), internal circuitry switches that current regulator's return path from GND to NEG to provide enough voltage across that regulator to overcome dropout. When VLED rises to 250mV (typ), the return of that current regulator is switched back from NEG to GND. Each current regulator is independently monitored

to detect when switchover is required. Since the LED current is switched for only the individual LED current regulators requiring higher voltage, power consumption is minimized.

Enable and Dimming Control Input (ENA, ENB)

ENA and ENB inputs have dual functions: LED on/off control and PWM or serial-pulse dimming control. See Table 1 for details. For the MAX8848Y, ENA functions as on/off control and serial-pulse dimming control for LED1–LED5. ENB functions as on/off control and serial-pulse dimming control for LED6 and LED7. For the MAX8848Z, only ENA functions as on/off control as well as PWM dimming control for LED1–LED7.

PWM Dimming Control (MAX8848Z)

When V_{IN} is above its undervoltage lockout threshold, UVLO, apply a PWM signal to ENA to set the corresponding WLED current (see Table 1) that is proportional to the signal duty cycle (0% duty cycle corresponds to zero LED current and 100% duty cycle corresponds to full LED current). The allowed PWM frequency range is from 200Hz to 200kHz. If PWM dimming control is not required, ENA works as a simple on/off control.

Serial-Pulse Dimming Control (MAX8848Y)

The MAX8848Y uses ENA/ENB as a serial-pulse control interface to program the intensity of LED1-LED7. When the LEDs are enabled by driving ENA/ENB high, the MAX8848Y ramps LED current to 24mA. Subsequent pulses on ENA/ENB reduce the LED current from 24mA to 0.1mA in 31 steps. After the current reaches 0.1mA, the next pulse restores the current to 24mA. See Table 2

Table 1. ENA and ENB Enable and Dimming Control

PART	ENA	ENB
MAX8848Y	LED1-LED5 enable and serial-pulse dimming control	LED6 and LED7 enable and serial-pulse dimming control
MAX8848Z	LED1-LED7 enable and PWM dimming control	_

for the LED current values and the corresponding ENA/ENB pulse count. Figure 2 shows a timing diagram for ENA/ENB.

If dimming control is not required, ENA/ENB works as a simple on/off logic control. Drive ENA/ENB high for

at least 120µs to enable the LED current regulators, or drive ENA/ENB low for greater than 8ms (typ) to place the LED current regulators in shutdown. The LED current regulators operate at 100% brightness and off under these conditions.

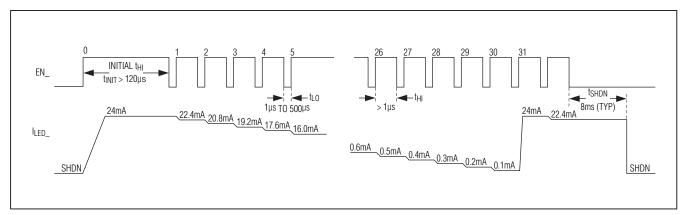


Figure 2. Timing Charateristics for LED Serial-Pulse Dimming Control

Table 2. ENA/ENB Serial-Pulse Dimming Count and Programmed LED_ Currents

EN_ PULSE COUNT	PROGRAMMED LED_ CURRENT (mA)	EN_ PULSE COUNT	PROGRAMMED LED_ CURRENT (mA)
Startup or EN_high	24.0	16	2.8
1	22.4	17	2.4
2	20.8	18	2.0
3	19.2	19	1.6
4	17.6	20	1.4
5	16.0	21	1.2
6	14.4	22	1.0
7	12.8	23	0.8
8	11.2	24	0.7
9	9.6	25	0.6
10	8.0	26	0.5
11	6.4	27	0.4
12	5.6	28	0.3
13	4.8	29	0.2
14	4.0	30	0.1
15	3.2	31	24.0

Low LED Current Levels

The MAX8848Y internally generates a PWM signal to obtain higher resolution at lower currents. See the Single-Wire Serial-Pulse Dimming Response (MAX8848Y) graph in the *Typical Operating Characteristics* section. When the LED current is set below 6.4mA, the IC adjusts not only LED DC current, but the duty cycle that is controlled by the PWM signal. The frequency of the PWM dimming signal is set at 16kHz with a minimum duty cycle of 1/8 to avoid the LED flickering effect to human eyes and also to avoid interference in the audio frequency range. Table 3 shows the current level and the corresponding duty cycle.

Shutdown Mode

The MAX8848Y/MAX8848Z are in shutdown mode when both ENA and ENB are held low for 8ms or longer. In shutdown, NEG is pulled to GND with a $10k\Omega$ internal resistor.

Temperature Derating Function

The MAX8848Y/MAX8848Z contain a derating function that automatically limits the LED current at high temperatures in accordance with the recommended derating curve of popular white LEDs. The derating function enables the safe usage of higher LED current at room temperature, thus reducing the number of LEDs required to backlight the display. The derating circuit lowers the LED current at approximately 2.5%/°C once the die temperature is above +60°C. The typical derating function characteristic is shown in the *Typical Operating Characteristics*.

Table 3. Internal PWM Duty Cycle vs. LED Set Current

ILED (mA)	MAXIMUM I _{LED} (mA)*	DUTY CYCLE (n/8)	ILED (mA)	MAXIMUM I _{LED} (mA)*	DUTY CYCLE (n/8)
6.4	6.4	8	1.2	1.6	6
5.6	6.4	7	1.0	1.6	5
4.8	6.4	6	0.8	0.8	8
4.0	6.4	5	0.7	0.8	7
3.2	3.2	8	0.6	0.8	6
2.8	3.2	7	0.5	0.8	5
2.4	3.2	6	0.4	0.8	4
2.0	3.2	5	0.3	0.8	3
1.6	1.6	8	0.2	0.8	2
1.4	1.6	7	0.1	0.8	1

*Maximum I_{LED} is the full reference current when the internal PWM signal has 100% duty cycle at the lower level currents.

Power-Up LED Short Detection and Open-Fault Protection

The MAX8848Y/MAX8848Z contain special circuitry to detect short-circuit conditions at power-up and disable the corresponding current regulator to avoid wasting battery current. Connect any unused LED_ to IN to disable the corresponding current regulator. If an LED fails short-circuit detection after startup, the current regulator continues the current regulated operation until IC power is cycled and the short circuit is detected during the subsequent startup.

An open-circuit LED failure drives the voltage on the corresponding LED current regulator output below the switchover threshold, enabling the negative charge pump.

Thermal Shutdown

The MAX8848Y/MAX8848Z include a thermal-limit circuit that shuts down the IC above approximately +160°C. The IC turns on after it cools by approximately 20°C.

Applications Information

Input Ripple

For LED drivers, input ripple is more important than output ripple. The amount of input ripple depends on the source supply's output impedance. Add a lowpass filter to the input of the MAX8848Y/MAX8848Z to further reduce input ripple. Alternatively, increasing $C_{\rm IN}$ from 1.0µF to 2.2µF (or 4.7µF) cuts input ripple in half (or in fourth) with only a small increase in footprint.

Capacitor Selection

Ceramic capacitors are recommended due to their small size, low cost, and low ESR. Select ceramic capacitors that maintain their capacitance over temperature and DC bias. Capacitors with X5R or X7R temperature characteristics generally perform well. Recommended values are shown in the *Typical Operating Circuit*. Using a larger value input capacitor helps to reduce input ripple (see the *Input Ripple* section).

PCB Layout and Routing

The MAX8848Y/MAX8848Z are high-frequency switched-capacitor voltage inverters. For best circuit performance, use a solid ground plane and place all capacitors as close as possible to the IC. Use large traces for the power-supply inputs to minimize losses due to parasitic trace resistance and to route heat away from the device. Refer to the MAX8848Z evaluation kit data sheet for an example PCB layout.

Chip Information

_Package Information

PROCESS: BICMOS

For the latest package outline information and land patterns, go to www.maxim-ic.com/packages. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

PACKAGE TYPE	PACKAGE CODE	DOCUMENT NO.
16 Thin OFN-FP	T1633+5	21-0136

Revision History

REVISION NUMBER	REVISION DATE	DESCRIPTION	PAGES CHANGED
0	4/10	Initial release	_

Maxim cannot assume responsibility for use of any circuitry other than circuitry entirely embodied in a Maxim product. No circuit patent licenses are implied. Maxim reserves the right to change the circuitry and specifications without notice at any time.